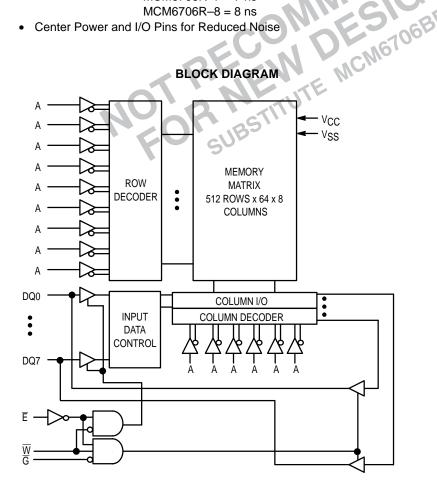
32K x 8 Bit Static Random Access **Memory**

The MCM6706R is a 262,144 bit static random access memory organized as 32,768 words of 8 bits, fabricated using high performance silicon-gate BiCMOS technology. Static design eliminates the need for external clocks or timing strobes.

Output enable (\overline{G}) is a special control feature that provides increased system flexibility and eliminates bus contention problems.

The MCM6706R meets JEDEC standards and is available in a revolutionary pinout 300 mil, 32-lead surface-mount SOJ package.

- Single 5.0 V \pm 10% Power Supply
- Fully Static No Clock or Timing Strobes Necessary
- All Inputs and Outputs Are TTL Compatible ٠
- Three State Outputs
- Fast Access Times: MCM6706R-6 = 6 ns ٠
 - MCM6706R-7 = 7 ns
 - MCM6706R-8 = 8 ns
- Center Power and I/O Pins for Reduced Noise



MCM6706R



PIN	I ASSIG	NMI	ENT
A0 [1•	32	D NC
A1 [2	31	A14
A2 [3	30] A13
A3 [4	29	A12
ĒD	5	28	<u>] </u>
DQ0 [6	27	
	7	26	
V _{CC} [8	25	□ v _{ss}
∨ss [9	24	□ v _{cc}
DQ2 [10	23] DQ5
DQ3 [11	22	DQ4
ΨC	12	21	D A11
A4 [13	20	A10
A5 🛙	14	19	A 9
A6 🛛	15	18	D A8
А7 🛛	16	17] NC
•			-

SNE

	PIN NAMES
W E G DQ0 - DQ3 V _{CC} V _{SS}	Address Write Enable Chip Enable Output Enable Data Input/Output + 5 V Power Supply Ground No Connection

TRUTH TABLE

E	G	W	Mode	I/O Pin	Cycle
Н	Х	Х	Not Selected	High–Z	_
L	Н	Н	Read	High–Z	—
L	L	н	Read	Dout	Read Cycle
L	Х	L	Write	D _{in}	Write Cycle

ABSOLUTE MAXIMUM RATINGS (See Note)

	,		
Rating	Symbol	Value	Unit
Power Supply Voltage	Vcc	– 0.5 to + 7.0	V
Voltage Relative to V _{SS} for Any Pin Except V _{CC}	V _{in} , V _{out}	– 0.5 to V _{CC} + 0.5	V
Output Current	lout	± 30	mA
Power Dissipation	PD	2.0	W
Temperature Under Bias	T _{bias}	– 10 to + 85	°C
Operating Temperature	TA	0 to + 70	°C
Storage Temperature — Plastic	T _{stg}	– 55 to + 125	°C

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields; however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit.

This BiCMOS memory circuit has been designed to meet the dc and ac specifications shown in the tables, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow of at least 500 linear feet per minute is maintained.

NOTE: Permanent device damage may occur if ABSOLUTE MAXIMUM RATINGS are exceeded. Functional operation should be restricted to RECOMMENDED OPER-ATING CONDITIONS. Exposure to higher than recommended voltages for extended periods of time could affect device reliability.

DC OPERATING CONDITIONS AND CHARACTERISTICS

(V_{CC} = 5.0 V \pm 10%, T_A = 0 to 70°C, Unless Otherwise Noted)

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Min	Тур	Max	Unit
Supply Voltage (Operating Voltage Range)	VCC	4.5	5.0	5.5	V
Input High Voltage	VIH	2.2	—	V _{CC} + 0.3*	V
Input Low Voltage	VIL	- 0.5**	_	0.8	V

* V_{IH} (max) = V_{CC} + 0.3 V dc; V_{IH} (max) = V_{CC} + 2.0 V ac (pulse width \leq 2.0 ns) or I \leq 30.0 mA.

** V_{IL} (min) = -0.5 V dc @ 30.0 mA; V_{IL} (min) = -2.0 V ac (pulse width \leq 2.0 ns) or I \leq 30.0 mA.

DC CHARACTERISTICS

Parameter	Symbol	Min	Max	Unit
Input Leakage Current (All Inputs, V _{in} = 0 to V _{CC})	l _{lkg(l)}	_	± 1.0	μΑ
Output Leakage Current ($\overline{E} = V_{IH}$ or $\overline{G} = V_{IH}$, $V_{out} = 0$ to V_{CC})	l _{lkg(O)}	_	±1.0	μΑ
Output High Voltage (I _{OH} = - 4.0 mA)	VOH	2.4		V
Output Low Voltage (I _{OL} = + 8.0 mA)	VOL	_	0.4	V

POWER SUPPLY CURRENTS

Parameter	Symbol	6706R-6	6706R-7	6706R-8	Unit	Notes
AC Active Supply Current ($I_{out} = 0 \text{ mA}, V_{CC} = \max, f = f_{max}$)	ICCA	205	200	195	mA	1, 2, 3
AC Standby Current ($\overline{E} = V_{IH}$, $V_{CC} = max$, $f = f_{max}$)	I _{SB1}	95	90	85	mA	1, 2. 3
$\begin{array}{l} CMOS \; Standby \; Current \; (V_{CC} = max, f = 0 \; MHz, \; \overline{E} \geq V_{CC} - 0.2 \; V, \\ V_{in} \leq V_{SS}, \; or \geq V_{CC} - 0.2 \; V) \end{array}$	I _{SB2}	20	20	20	mA	

NOTES:

1. Reference AC Operating Conditions and Characteristics for input and timing (V_{IH}/V_{IL} , t_r/t_f , pulse level 0 to 3.0 V, V_{IH} = 3.0 V).

2. All addresses transition simultaneously low (LSB) and then high (MSB).

3. Data states are all zero.

CAPACITANCE (f = 1.0 MHz, dV = 3.0 V, T_A = 25°C, Periodically Sampled Rather Than 100% Tested)

Parameter	Symbol	Max	Unit
Address Input Capacitance	C _{in}	5	pF
Control Pin Input Capacitance (\overline{E} , \overline{G} , \overline{W})	C _{in}	6	pF
I/O Capacitance	Cout	6	pF

AC OPERATING CONDITIONS AND CHARACTERISTICS

(V_{CC} = 5.0 V \pm 10%, T_A = 0 to + 70°C, Unless Otherwise Noted)

Input Timing Measurement Reference Level
Input Pulse Levels 0 to 3.0 V
Input Rise/Fall Time 2 ns

READ CYCLE (See Notes 1 and 2)

		MCM6706R-6		R–6 MCM6706R–7		MCM6706R-8			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
Read Cycle Time	tAVAV	6	_	7	_	8	_	ns	3
Address Access Time	^t AVQV	_	6	_	7	_	8	ns	
Chip Enable Access Time	^t ELQV	—	6	—	7	—	8	ns	
Output Enable Access Time	^t GLQV	_	4	_	4	_	4	ns	
Output Hold from Address Change	tAXQX	3	_	3	_	3	_	ns	
Chip Enable Low to Output Active	^t ELQX	3	_	3	—	3	_	ns	4 ,5, 6
Chip Enable High to Output High–Z	^t EHQZ	0	3	0	3.5	0	4	ns	4, 5, 6
Output Enable Low to Output Active	^t GLQX	0	_	0	_	0	_	ns	4, 5, 6
Output Enable High to Output High-Z	^t GHQZ	0	3	0	3.5	0	4	ns	4, 5, 6
NOTES:									

1. \overline{W} is high for read cycle.

- 2. Product sensitivities to noise require proper grounding and decoupling of power supplies as well as minimization or elimination of bus contention conditions during read and write cycles.
- 3. All read cycle timing is referenced from the last valid address to the first transitioning address.
- 4. At any given voltage and temperature, t_{EHQZ} max < t_{ELQX} min, and t_{GHQZ} max < t_{GLQX} min, both for a given device and from device to device.
- 5. Transition is measured 200 mV from steady-state voltage with load of Figure 1B.
- 6. This parameter is sampled and not 100% tested.
- 7. Device is continuously selected ($\overline{E} = V_{IL}, \overline{G} = V_{IL}$).
- 8. Addresses valid prior to or coincident with $\overline{\mathsf{E}}$ going low.

AC TEST LOADS

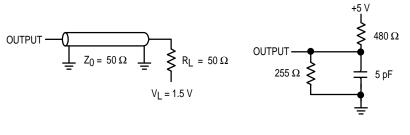


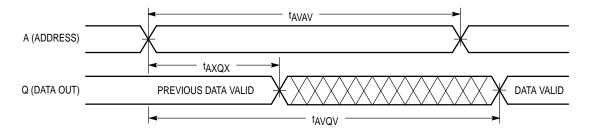
Figure 1A



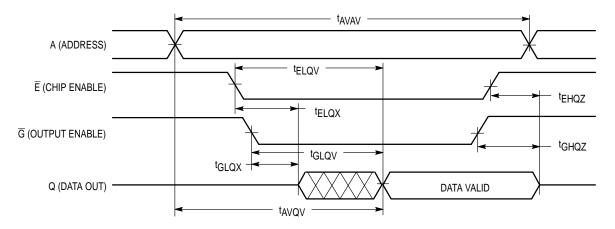
TIMING LIMITS

The table of timing values shows either a minimum or a maximum limit for each parameter. Input requirements are specified from the external system point of view. Thus, address setup time is shown as a minimum since the system must supply at least that much time (even though most devices do not require it). On the other hand, responses from the memory are specified from the device point of view. Thus, the access time is shown as a maximum since the device never provides data later than that time.

READ CYCLE 1 (See Note 7)







WRITE CYCLE 1 (W Controlled, See Notes 1 and 2)

		MCM6706R-6		6 MCM6706R-7		7 MCM6706R-8			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
Write Cycle Time	^t AVAV	6	—	7	_	8	_	ns	3
Address Setup Time	^t AVWL	0	—	0	_	0		ns	
Address Valid to End of Write	^t AVWH	6	—	7	_	8		ns	
Write Pulse Width	^t WLWH [,] ^t WLEH	6	_	7	_	8	_	ns	
Data Valid to End of Write	^t DVWH	3	—	3.5	_	4	—	ns	
Data Hold Time	^t WHDX	0	—	0	_	0	—	ns	
Write Low to Data High–Z	tWLQZ	0	3.5	0	3.5	0	4	ns	4, 5, 6
Write High to Output Active	^t WHQX	3	—	3	_	3	—	ns	4, 5, 6
Write Recovery Time	tWHAX	0	_	0	_	0		ns	

NOTES:

1. A write occurs during the overlap of \overline{E} low and \overline{W} low.

2. Product sensitivites to noise require proper grounding and decoupling of power supplies as well as minimization or elimination of bus contention conditions during read and write cycles.

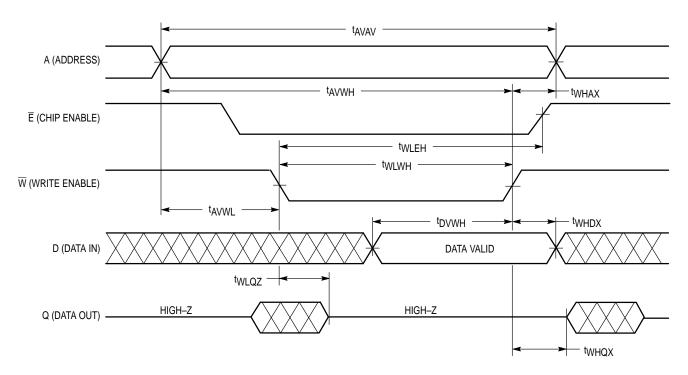
3. All write cycle timings are referenced from the last valid address to the first transitioning address.

4. Transition is measured 200 mV from steady-state voltage with load of Figure 1B.

5. Parameter is sampled and not 100% tested.

6. At any given voltage and temperature, t_{WLQZ} max is < t_{WHQX} min both for a given device and from device to device.

WRITE CYCLE 1



WRITE CYCLE 2 (E Controlled, See Notes 1 and 2)

		MCM6706R-6 MCM6706R-7		MCM6706R-8					
Parameter	Symbol	Min	Мах	Min	Мах	Min	Max	Unit	Notes
Write Cycle Time	t _{AVAV}	6	-	7	_	8	-	ns	3
Address Setup Time	^t AVEL	0	-	0	_	0	-	ns	
Address Valid to End of Write	^t AVEH	6		7	_	8	-	ns	
Chip Enable to End of Write	^t ELWH [,] ^t ELEH	5		6		7	_	ns	4,5
Data Valid to End of Write	^t DVEH	3	_	3.5	_	4	_	ns	
Data Hold Time	^t EHDX	0	_	0	_	0	_	ns	
Write Recovery Time	^t EHAX	0		0		0	—	ns	

NOTES:

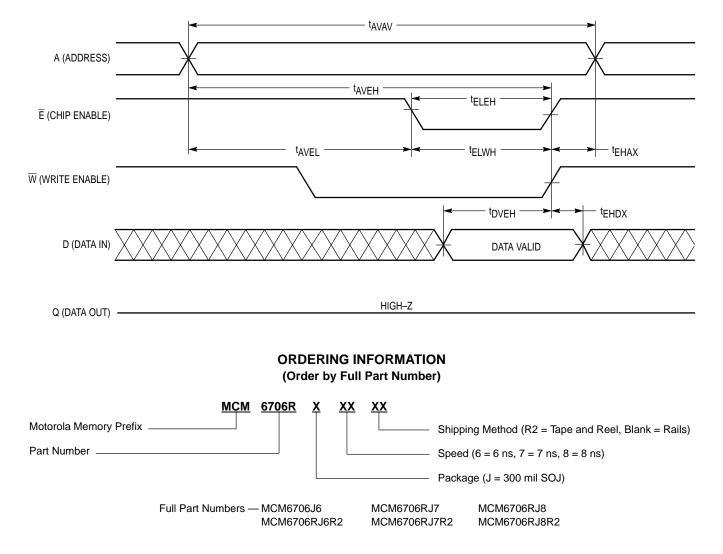
1. A write occurs during the overlap of \overline{E} low and \overline{W} low.

2. Product sensitivites to noise require proper grounding and decoupling of power supplies as well as minimization or elimination of bus contention conditions during read and write cycles.

3. All write cycle timing is referenced from the last valid address to the first transitioning address.

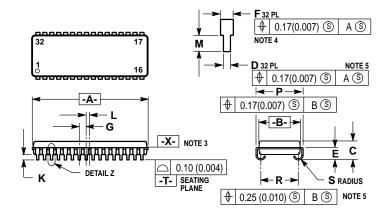
4. If \overline{E} goes low coincident with or after \overline{W} goes low, the output will remain in a high impedance condition.

5. If \overline{E} goes high coincident with or before \overline{W} goes high, the output will remain in a high impedance condition.



WRITE CYCLE 2

32–LEAD 300 MIL SOJ CASE 857-02



NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2
- CONTROLLING DIMENSION: INCH. DATUM PLANE -X- LOCATED AT TOP OF MOLD 3. PARTING LINE AND COINCIDENT WITH TOP OF LEAD, WHERE LEAD EXITS BODY.
- TO BE DETERMINED AT PLANE -X-TO BE DETERMINED AT PLANE -T-
- 5. 6. DIMENSION A & B DO NOT INCLUDE MOLD
- PROTRUSION. MOLD PROTRUSION SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
- 857-01 IS OBSOLETE, NEW STANDARD 857-02. 7

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	20.83	21.08	0.820	0.830
В	7.50	7.74	0.295	0.305
С	3.26	3.75	0.128	0.148
D	0.41	0.50	0.016	0.020
E	2.24	2.48	0.088	0.098
F	0.67	0.81	0.026	0.032
G	1.27 BSC		0.050 BSC	
K	0.89	1.14	0.035	0.045
L	0.64 BSC		0.025 BSC	
N	0.76	1.14	0.030	0.045
Р	8.38	8.64	0.330	0.340
R	6.60	6.86	0.260	0.270
S	0.77	1.01	0.030	0.040

Motorola reserves the right to make changes without further notice to any products herein. Motorola makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does Motorola assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation consequential or incidental damages. "Typical" parameters can and do vary in different applications. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. Motorola does not convey any license under its patent rights nor the rights of others. Motorola products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the Motorola product could create a situation where personal injury or death may occur. Should Buyer purchase or use Motorola products for any such unintended or unauthorized application, Buyer shall indemnify and hold Motorola and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that Motorola was negligent regarding the design or manufacture of the part. Motorola and 🦇 are registered trademarks of Motorola, Inc. Motorola, Inc. is an Equal Opportunity/Affirmative Action Employer.

Literature Distribution Centers: USA/EUROPE: Motorola Literature Distribution; P.O. Box 20912; Phoenix, Arizona 85036. JAPAN: Nippon Motorola Ltd.; 4–32–1, Nishi–Gotanda, Shinagawa–ku, Tokyo 141, Japan. ASIA PACIFIC: Motorola Semiconductors H.K. Ltd.; Silicon Harbour Center, No. 2 Dai King Street, Tai Po Industrial Estate, Tai Po, N.T., Hong Kong.



♦ CODELINE TO BE PLACED HERE

